

42.P17274



OK to enter

BT

4/20/06

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Fu, et al.

Serial No.: 10/672,357

Filed: September 25, 2003

For: PROCESS FOR LOW K
DIELECTRIC PLASMA ETCHING WITH
HIGH SELECTIVITY TO DEEP UV
PHOTORESIST

Examiner: Binh X. Tran

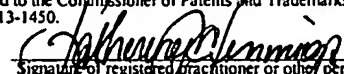
Group Art Unit: 1765

Attorney Docket No.: 42.P17274

CERTIFICATE OF MAILING

I hereby certify that this paper or fee along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner of Patents and Trademarks, Alexandria, VA. 22313-1450.

April 6, 2006
Date of Deposit


Signature of registered practitioner or other person
having reasonable basis to expect mailing to occur
on date of deposit shown pursuant to 37 C.F.R. §
1.8(a)(1)(ii)

Katherine Jennings

Typed/printed name of person whose signature is
contained above

**Response Under 37 C.F.R §1.116
Expedited Procedure
Technology Center 1700**

AMENDMENT

Hon. Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

In response to the March 28, 2006 Final Office Action, please consider the following
amendments and remarks:

Amendments to the Claims begin on page 2.

Remarks/Arguments begin on page 7.